501911538 05/07/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chun-Chieh Wong	05/03/2012
Cheng-Yu Wang	05/03/2012

RECEIVING PARTY DATA

Name:	ASUSTEK COMPUTER INC.	
Street Address:	No.15, Lide Rd., Beitou Dist.	
City:	Taipei City TAIWAN	
State/Country:		
Postal Code:	112	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13463828

CORRESPONDENCE DATA

Fax Number: (510)580-7280

Email: usa@jcipgroup.com.tw

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE

Address Line 1: 7F.-1, NO. 100, ROOSEVELT RD., SEC. 2,

Address Line 4: Taipei, TAIWAN 100

ATTORNEY DOCKET NUMBER: 38119-US-PA

NAME OF SUBMITTER: Belinda Lee

Total Attachments: 2

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PATENT REEL: 028162 FRAME: 0385 840.00 13

ASSIGNMENT

WHEREAS,

1. Chun-Chieh Wong

2. Cheng-Yu Wang

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: HEAT DISSIPATING MODULE AND HEAT DISSIPATING METHOD
THEREOF

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, ASUSTEK COMPUTER INC.

of No.15, Lide Rd., Beitou Dist., Taipei City 112, Taiwan (R.O.C.)

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

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Signature: Chun Chieh Wong Sole or First Joint Inventor: Chun-Chieh Wong	Date: May 3, 2012
Signature: Cheng In Mana	Date: May 3, 2012

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s)